Investigation of microbiologically influenced corrosion

3. Two-year exposure of aluminium to Penicillium frequentans, Aspergillus niger and Bacillus mycoides

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Aluminium samples were for two years exposed to the microorganisms Penicillium frequentans, Aspergillus niger and Bacillus mycoides. The strains of microorganisms were isolated from Al, Cu, Zn and steel samples, which had been exposed to marine, rural and urban sites in Lithuania. Microbially influenced corrosion inhibition (MICI) of aluminium was determined using polarization resistance as a criterion. EIS data indicated a two-layer structure on the colonized aluminium samples: a native aluminium oxide and a layer that resulted from the oxide interaction with metabolism products of microorganisms. An increase in aluminium oxide layer resistance but a decrease in the layer thickness implied that microorganisms might act as passivity promoters at the sites of localized corrosion attack (passive layer defects, pores, microcracks, etc). This conclusion was supported by scanning electron microscopy (SEM) observations.

INTRODUCTION

The present study follows our previous investigations of microbiological corrosion induced by microorganisms isolated from samples exposed in the outdoor stations covering different environmental conditions in Lithuania [1, 2]. We identified ca. 70 bacterial and fungal populations, which colonized metal samples during a two-year exposure to urban, suburban, rural and marine conditions [1, 2].

Microbially induced corrosion acceleration was detected for zinc samples subjected for two years the influence of Aspergillus niger, Bacillus mycoides and Penicillium frequentans strains [2]. EIS data indicated a three-layer structure developed on zinc affected by the microorganisms. It was concluded that the reasons for microbial corrosion acceleration lie primarily in diminishing the thickness of the inner layer which had the greatest passivating capacity. The intermediate and outer layers of corrosion products had a several times lower passivating capacity as compared to a counterpart free of microorganisms.

The microbial products of importance for microbial induced corrosion (MIC) include organic and inorganic acids, hydrogen sulphide, carbon dioxide, hydrogenase, etc. MIC is a complex interaction among the microbial population, the environment and the metal substrate. However, the main factor which ultimately determines the character of corrosion is the kind of metal substrate.

The aim of the present study was to elucidate the influence of the microorganisms Bacillus mycoides, Aspergillus niger and Penicillium frequentans on aluminium corrosion. Aluminium and its alloys, due to a low specific weight and high strength/weight ratio, are of increasing importance in a variety of technical applications such as food equipment, chemical processing, transport and structural fields, especially where seawater exposure is involved [3]. The corro-
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Polarization resistance ($R_p$) change during two-year exposure of Al to humid atmosphere and of Al subjected to the effect of Penicillium frequentans, Aspergillus niger and Bacillus mycoides

Fig. 1. Polarization resistance ($R_p$) change during two-year exposure of Al to humid atmosphere and of Al subjected to the effect of Penicillium frequentans, Aspergillus niger and Bacillus mycoides

EIS data for pristine Al sample and for that exposed for two years to humid atmosphere

Fig. 2. EIS data for pristine Al sample and for that exposed for two years to humid atmosphere
time intervals of 3, 7, 15 and 24 months the samples were sprayed repeatedly. Before that, some samples had been taken from the exposure vessels for visual evaluation, EIS investigations and vitality test of the microorganisms.

An electrochemical glass cell was equipped with holes for a metal specimen as well as Ag/AgCl reference and Pt counter electrodes. A metal sample was mounted in a special holder and placed in a cell filled with 3.5% NaCl. EIS measurements were started after 5–10 min of exposure to the solution. The EIS experiments were performed using an IM6 Zahner apparatus (Germany) at an open circuit potential and signal amplitude of $\Delta E = \pm 5-10$ mV. After measurements the samples were rinsed with distilled water, dried and newly infected with microorganisms.

RESULTS AND DISCUSSION

The polarization resistance ($R_p$) change during two years of exposure of aluminium samples is shown in Fig. 1. As commonly known, the corrosion current density is in inverse proportion to $R_p$. The corrosion activity of the blank sample does not change significantly during the exposure (curve 1). It is also obvious that the samples colonized by microorganisms exhibit a much lower activity (curves 2–4). An especially great inhibiting influence is characteristic of *Penicilium frequentans*: the highest $R_p$ value (after 15 month exposure) is more than twenty times higher as compared to the counterpart free of microorganisms (curves 4 and 1, respectively). The data show the following sequence of the inhibiting capability of the strains studied: *Penicilium frequentans* $>$ *Aspergillus niger* $>$ *Bacillus mycoides*.

The EIS diagrams (the impedance $Z$ dependence on frequency $f$) for pristine Al and that exposed to a humid atmosphere for two years are given in Fig. 2. The data were fitted using a one time constant model, i.e. an equivalent circuit consisting of one $R_t$-CPE element (charge transfer resistance - constant phase element) and the uncompensated ohmic resistance ($R_\Omega$) in series. This model assumes one passive layer to be developed on aluminium (the fitting parameters are given in Table 1). The impedance values at a low frequency domain ($Z_{\omega \rightarrow 0}$), which characterizes the polarization resistance, show a high degree of stability: the sample activity does not change significantly during a two-year exposure to a humid atmosphere. At the same time, a divergence in phase angle data appears during the exposure.

Aluminium is known to corrode not uniformly because of preferential attack on grain boundaries. The localized corrosion of Al alloys was indicated by EIS as an appearance of a second time constant in the low frequency region [4, 5]. The authors have pointed out that the effect is usually partially masked by the scatter of the data at low frequencies. The data in Fig. 2 suggest the possible contribution of the localized corrosion phenomena, which is evidenced by the typical phase angle divergence at low frequencies (symbols) from the one time constant model (line). A typically observed low-frequency minimum is partially masked by the data scatter below 0.1 Hz. It was difficult to interpret the analogous data obtained for the exposed sample (curve 2, Fig. 2) due to a great data scatter of the experimental data below 1 Hz (the scattered data are not shown in the figure).

Figures 3–5 show the EIS diagrams obtained for samples colonized by microorganisms. The data for each sample were fitted assuming one and two $R_t$-CPE elements and $R_\Omega$ in series. There are some distinctive zones on the phase angle diagrams, which
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Table 1. Fitting parameters for the EIS data (Figs. 2-5) obtained for pristine Al sample and those exposed to humid atmosphere for two years

<table>
<thead>
<tr>
<th>Sample</th>
<th>C₁, μF cm⁻²</th>
<th>C₂, μF cm⁻²</th>
<th>R₁, kΩ cm²</th>
<th>R₂, kΩ cm²</th>
</tr>
</thead>
<tbody>
<tr>
<td>Al, pristine</td>
<td>3.6</td>
<td>-</td>
<td>5.9</td>
<td>-</td>
</tr>
<tr>
<td>Al, exposed</td>
<td>2.2</td>
<td>-</td>
<td>8.2</td>
<td>-</td>
</tr>
<tr>
<td>Al + Bacillus mycoides</td>
<td>7.5</td>
<td>2.3</td>
<td>31.3</td>
<td>3.5</td>
</tr>
<tr>
<td>Al + Aspergillus niger</td>
<td>14.7</td>
<td>2.0</td>
<td>59.9</td>
<td>22.5</td>
</tr>
<tr>
<td>Al + Penicilium frequentans</td>
<td>1.7</td>
<td>40.3</td>
<td>152.6</td>
<td>4.5</td>
</tr>
</tbody>
</table>

are in a better agreement with the model of two R-CPE elements. Thus, EIS measurements indicate a two-layer structure to be developed on Al during MIC. The first layer should be composed of an aluminium oxide and the second one should result from the oxide interaction with microorganisms (the oxide/biofilm interface). Each layer is characterized in Table 1 by the charge transfer resistance (R₁ and R₂) and capacitance (C₁ and C₂). The latter define the layer thickness, which is in inverse proportion to the capacitance (strictly speaking, this is true assuming that the relative permittivity does not differ significantly for different layers).

The studies of the samples performed by X-ray diffraction (XRD) indicated a mostly thick corrosion product layer on the sample with Penicilium frequentans, while the thinnest layer was characteristic of the sample without microorganisms [6]. These results are in agreement with those of EIS investigations, which led to analogous conclusion (Table 1).

It is interesting to note that even a three-layer structure was identified by EIS on the aluminium upon exposure to the atmosphere [7]. The structure consisted of a native oxide, a corrosion layer on the oxidized aluminium and a surface contamination layer (mainly sulphate and chloride species).

The R₁ value for the colonised samples was much higher than that for blank Al (R₁ = 31±153 kΩ cm² vs. R₁ = 8.2 kΩ cm², respectively). At the same time, the inner layer on the samples with microorganisms was several times thinner (Bacillus mycoides and Aspergillus niger) or had a similar thickness (Penicilium frequentans).

The contribution of the outer layer to charge transfer kinetics was less as compared to that of the inner one. For instance, the outer layer in case of Penicilium frequentans had the resistance R₂ = 4.5 kΩ cm², while the resistance of the inner layer was R₁ = 153 kΩ cm². This difference is quite understandable considering that the outer layer may have a disordered and porous structure due to influence of microorganisms.

Thus, a conclusion may be drawn that the reasons for the inhibiting action of microorganisms lies primarily in the increase of the charge transfer resistance through the inner oxide layer. It is important to stress that this effect cannot be attributed to the increase of the layer thickness.

As already noted, aluminium usually corrodes not uniformly because of preferential attack on grain boundaries, which results in a symptomatic feature – appearance of a second time constant in the low frequency region of the phase angle diagram. The determined increase in R₁ and decrease or similarity in d imply that microorganisms may affect the weak
sites at the metal/oxide interface (defects, pores, microcracks, etc.) where localized corrosion may take place. Microorganisms colonize these sites preferentially and the induced MIC process causes development of aluminium oxide which, being a valve metal oxide, has a great barrier effect on electron transfer. In other words, microorganisms may act as promoters of a “healing” process at the sites of localized corrosion attack.

The above suggestion supports observations by scanning electron microscopy (SEM) (Fig. 6). The micrograph clearly shows that the aluminium sample is colonised by Aspergillus niger preferentially at the microcracks of the oxide layer.

The results presented here with Al samples and those dealing with Zn samples presented previously [2] demonstrate that the microorganisms under study may act both as corrosion accelerators and inhibitors, depending upon the kind of metal they colonize. Pure zinc corrodes more or less uniformly (no deep pitting observed in many cases) with development of a thick and porous corrosion product layer of a low passivating capacity. By contrast, localised corrosion is characteristic of aluminium; its passive layer is very thin (several nanometers), but has a high insulating capacity. The microorganisms are capable of disintegrating the corrosion product layers on zinc, while the aluminium oxide layer is generally stable against microorganisms. If local MIC attack occurs, it leads to passivation of these weak sites due to a local development of aluminium oxide – a highly insulating barrier to charge transfer.

CONCLUSIONS

Microbially induced corrosion inhibition was determined for aluminium samples. The microorganisms were in the following sequence of inhibiting capability: Penicilium frequentans > Aspergillus niger > Bacillus mycoides. EIS measurements indicated a two-layer structure developed on Al during MIC: the inner aluminium oxide layer and the outer one, which develops due to the oxide interaction with metabolism products of the microorganisms. An increase in charge transfer resistance but not in layer thickness implies that microorganisms promote locally the passivity at sites of microdefects (pores, cracks, etc.). A preferential colonization of microcracks is evident from SEM investigations.

ACKNOWLEDGEMENTS

The authors remember with great respect Dr. E. Matulionis who passed away in 2003. He carried out
the SEM investigations at the Institute of Chemistry, Vilnius.

This study was carried out as part of a complex research program supported by the Lithuanian Science and Studies Foundation (Contract K-059).

Received 10 December 2004
Accepted 20 February 2005

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